

Final Product/Process Change Notification Document #: FPCN21130Z

Issue Date: 7 December 2015

Title of Change:	NCV7342-3 Timing Characteristics change (Datasheet update – Rev3)				
Proposed first ship date:	7 December 2016 or earlier after customer approval				
Contact information:	Contact your local ON Semiconductor Sales Office or Roman Buzas < <u>roman.buzas@onsemi.com</u> >.				
Samples:	Contact your local ON Semiconductor Sales Office				
Additional Reliability Data:	Contact your local ON Semiconductor Sales Office or Roman Buzas < <u>rom</u>	nan.buzas@onsemi.com>.			
Type of notification:	This is a Final Product/Process Change Notification (FPCN) sent to customers. FPCNs are issued 12 months prior to implementation of the change. ON Semiconductor will consider this change approved unless specific conditions of acceptance are provided in writing within 30 days of receipt of this notice. To do so, contact <pcn.support@onsemi.com>.</pcn.support@onsemi.com>				
Change Part Identification:	Affected products will be identified with date code.				
Change category:	☐ Wafer Fab Change ☐ Assembly Change ☐ Test Change ☐	☑ Other			
Change Sub-Category(s): ☐ Manufacturing Site Change/Addition ☐ Manufacturing Process Change ☐ Product specific change ☐ Other: ☐ All site(s) ☐ Naterial Change ☐ On Semiconductor site(s): ☐ External Foundry/Subcon site(s)					
Description and Purpose:					
Part number NCV7342MW3R2G added (NCV7342-3 DFN8 package) Package related parameters Moisture Sensitivity Level (MSL) added (SOIC-8 and DFN8 package) Lead Soldering temperature added (SOIC-8 and DFN8 package) Electrical Characteristics – Timing characteristics updated Delay Standby mode to Normal mode Max value changed to 90 μs (t _{d1(stb-nm)}) TxD dominant time for timeout Max value changed to 5 ms (t _{dom(TxD)}) Bus dominant timeout Max value changed to 5 ms (t _{dom(bus)})					

TEM001092 Rev. F Page 1 of 2



Final Product/Process Change Notification Document #: FPCN21130Z

Issue Date: 7 December 2015

Reliability Data Summary:

There is no change in reliability data. Characterization data is available upon request.

Electrical Characteristic Summary:

Delay Standby mode to Normal mode Max value change

Original Datasheet

Syn	nbol	Parameter	Conditions	Min	Тур	Max	Unit
TIMING CHARACTERISTICS (See Figure 7 and 8)							
t _{d(stt}	b-nm)	Delay standby mode to normal mode				47	μs

Updated Datasheet

Symbol	Parameter	Condition	Min	Тур	Max	Unit
t _{d(stb-nm)}	Delay standby mode to normal mode	NCV7342-0 version			47	μs
t _{d1(stb-nm)}	Delay standby mode to normal mode	NCV7342-3 version			90	μs

TxD dominant time for timeout and Bus dominant timeout Max value changed

Original Datasheet

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TIMING CHARACTERISTICS (See Figure 7 and 8)						
t _{dom(TxD)}	TxD dominant time for time out	$V_{TxD} = 0 V$	1.3		3	ms
t _{dom(bus)}	Bus dominant time out	Standby mode	1.3		3	ms

Updated Datasheet

- paatea - atao					
t _{dom(TxD)}	TxD dominant time for time out	V _{TxD} = 0 V	1.3	5	ms
t _{dom(bus)}	Bus dominant time out	Standby mode	1.3	5	ms

List of Affected Standard Parts:

Part Number	Qualification Vehicle		
NCV7342D13R2G	N/A		
NCV7342MW3R2G	N/A		

TEM001092 Rev. F Page 2 of 2